

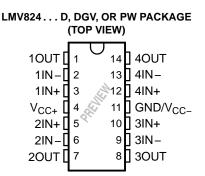
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FEATURES

- Qualification in Accordance With AEC-Q100⁽¹⁾
- Qualified for Automotive Applications
- Customer-Specific Configuration Control Can Be Supported Along With Major-Change Approval
- 2.5-V, 2.7-V, and 5-V Performance
- -40°C to 125°C Operation
- No Crossover Distortion
- Low Supply Current at V_{CC+} = 5 V:
 - LMV821...0.3 mA Typ
 - LMV822...0.5 mA Typ
 - LMV824...1 mA Typ
- Rail-to-Rail Output Swing
- Gain Bandwidth of 5.5 MHz Typ at 5 V
- Slew Rate of 1.9 V/µs Typ at 5 V
- (1) Contact factory for details. Q100 qualification data available on request.

DESCRIPTION/ORDERING INFORMATION

The LMV821 single, LMV822 dual, and LMV824 quad devices are low-voltage (2.5 V to 5.5 V), low-power commodity operational amplifiers. Electrical characteristics are very similar to the LMV3xx



LMV822...D OR DGK PACKAGE (TOP VIEW)

10UT [1IN – [1IN+ [2 3	U 8 7 6	-	V _{CC+} 2OUT 2IN –
1IN+ [GND/V _{CC-} [6 5	-	2IN – 2IN +

LMV821... DBV OR DCK PACKAGE (TOP VIEW)

	$\overline{\mathbf{T}}$	_	1
1	\cup	5	V _{CC+}
2			
3		4	ΙΟυτ
	1 2 3		

operational amplifiers (low supply current, rail-to-rail outputs, input common-mode range, which includes ground). However, the LMV8xx devices offer a higher bandwidth (5.5 MHz typical) and faster slew rate (1.9 V/µs typical).

The LMV8xx devices are cost-effective solutions for applications requiring low-voltage/low-power operation and space-saving considerations. The LMV821 is available in the ultra-small DCK package, which is approximately half the size of SOT-23-5. The DCK package saves space on printed circuit boards and enables the design of small portable electronic devices (cordless and cellular phones, laptops, PDAs, PCMIA). It also allows the designer to place the device closer to the signal source to reduce noise pickup and increase signal integrity.

The LMV8xx-Q1 devices are characterized for operation from -40°C to 125°C.

T _A	PACKAGE ⁽¹⁾			ORDERABLE PART NUMBER	TOP-SIDE MARKING ⁽²⁾
	Single	SC-70 – DCK	Reel of 3000	LMV821QDCKRQ1	PREVIEW
	Single	SOT-23 – DBV	Reel of 3000	LMV821QDBVRQ1	RB1_
	Dual	SOIC – D	Reel of 2500	LMV822QDRQ1	PREVIEW
–40°C to 125°C		MSOP/VSSOP - DGK	Reel of 2500	LMV822QDGKRQ1	R8B
		SOIC – D	Reel of 2500	LMV824QDRQ1	PREVIEW
	Quad	TSSOP – PW	Reel of 2000	LMV824QPWRQ1	PREVIEW
		TVSOP – DGV	Reel of 2000	LMV824QDGVRQ1	PREVIEW

ORDERING INFORMATION

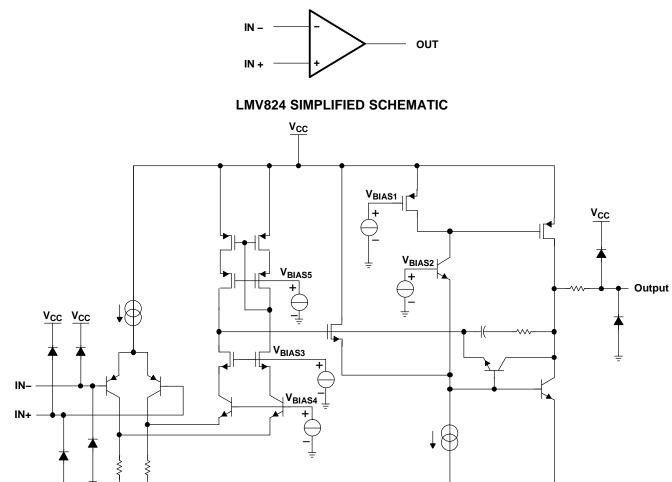
(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

(2) DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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SYMBOL (EACH AMPLIFIER)

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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

				MIN	MAX	UNIT
V _{CC}	Supply voltage ⁽²⁾				5.5	V
V_{ID}	Differential input voltage ⁽³⁾		$\pm V_{CC}$	V		
VI	Input voltage range (either input)			V _{CC-}	V _{CC+}	V
	Duration of output short circuit (one amplifier) to ground ⁽⁴⁾	At or below $T_A =$	25°C, V _{CC} ≤ 5.5 V	ι	Inlimited	
		D package	8 pin		97	
			14 pin		86	
		DBV package		206		
θ_{JA}	Package thermal impedance ⁽⁵⁾⁽⁶⁾	DCK package		252	°C/W	
		DGK package			172	
		DGV package			127	
		PW package			113	
TJ	Operating virtual junction temperature	·			150	°C
T _{stg}	Storage temperature range				150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

All voltage values (except differential voltages and V_{CC} specified for the measurement of I_{OS}) are with respect to the network GND.

(3) Differential voltages are at IN+ with respect to IN-.

(4)

- Short circuits from outputs to V_{CC} can cause excessive heating and eventual destruction. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient (5) temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability. The package thermal impedance is calculated in accordance with JESD 51-7.
- (6)

Recommended Operating Conditions

		MIN	MAX	UNIT
V_{CC}	Supply voltage (single-supply operation)	2.5	5	V
T _A	Operating free-air temperature	-40	125	°C

2.5-V Electrical Characteristics

 V_{CC+} = 2.5 V, V_{CC-} = 0 V, V_{IC} = 1 V, V_{O} = 1.25 V, and R_L > 1 M Ω (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	TEST CONDITIONS		MIN	TYP	MAX	UNIT
V	Innut offerst voltage			25°C		1	6	mV
V _{IO}	Input offset voltage			–40°C to 125°C			6	mv
		Link lavel	25°C	2.28	2.37			
	$V_{-2} = 2.5 V_{-1} R_{-1} = 600 O_{-1} to 1.25 V_{-1}$	High level	–40°C to 125°C	2.18				
		$V_{CC+} = 2.5 \text{ V}, \text{ R}_{L} = 600 \Omega \text{ to } 1.25 \text{ V}$		25°C		0.13	0.22	
	Output output		Low level	-40°C to 125°C			0.32	
Vo	Output swing		Link lavel	25°C	2.38	2.46		V
			High level	-40°C to 125°C	2.28			
		V_{CC+} = 2.5 V, R_L = 2 k Ω to 1.25 V	L avv lavval	25°C		0.08	0.14	
		Low level		–40°C to 125°C			0.22	



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2.7-V Electrical Characteristics

 V_{CC+} = 2.7 V, V_{CC-} = 0 V, V_{IC} = 1 V, V_{O} = 1.35 V, and R_{L} > 1 $M\Omega$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS		T _A	MIN	TYP	MAX	UNIT
	lanut effect velte			25°C		1	6	
V _{IO}	Input offset voltage			-40°C to 125°C			6	mV
α _{VIO}	Average temperature coefficient of input offset voltage			25°C		1		μV/°C
	Input biog ourrent			25°C		30	90	~ ^
I _{IB}	Input bias current			-40°C to 125°C			140	nA
	Input offset current			25°C		0.5	30	nA
I _{IO}	input onset current			-40°C to 125°C			50	ΠA
	Common-mode rejection ratio	$V_{\rm io} = 0$ to 1.7 V		25°C	70	85		dB
CIVIRR	Common-mode rejection ratio	$v_{\rm IC} = 0.001.7$ v	$V_{IC} = 0$ to 1.7 V		68			uБ
ık	Positive supply-voltage	$V_{CC+} = 1.7 V \text{ to } 4 V, V_{CC}$	_ = −1 V,	25°C	75	85		dB
+k _{SVR}	rejection ratio	$V_{O} = 0, V_{IC} = 0$		-40°C to 125°C	70			uВ
Ŀ	Negative supply-voltage	$V_{CC+} = 1.7 \text{ V}, V_{CC-} = -1$	V to -3.3 V,	25°C	73	85		d٦
-k _{SVR}	rejection ratio	$V_0 = 0, V_{IC} = 0$		-40°C to 125°C	70			dB
V _{ICR}	Common-mode input voltage range	CMRR ≥ 50 dB		25°C	-0.2 to 1.9	-0.3 to 2		V
		$R_{L} = 600 \ \Omega$ to 1.35 V,	Sourcing	25°C	90	100		dB
		$V_0^2 = 1.35 \text{ V to } 2.2 \text{ V}$	Sourcing	-40°C to 125°C	85			
		$R_1 = 600 \Omega$ to 1.35 V,	0.1.1.1	25°C	85	90		
	Large-signal voltage	$V_0^{L} = 1.35 \text{ V to } 0.5 \text{ V}$	Sinking	-40°C to 125°C	80			
	amplification	$R_1 = 2 k\Omega$ to 1.35 V,	0	25°C	95	100		
		$V_{O} = 1.35 \text{ V} \text{ to } 2.2 \text{ V}$	Sourcing	-40°C to 125°C	90			
		$\label{eq:RL} \begin{array}{l} R_{L} = 2 \; k\Omega \; \text{to} \; 1.35 \; V, \\ V_{O} = 1.35 \; V \; \text{to} \; 0.5 \; V \end{array}$	Sinking	25°C	90	95		+
				-40°C to 125°C	85			
			L Park Laural	25°C	2.5	2.58		
		V _{CC+} = 2.7 V,	High level	-40°C to 125°C	2.4			
		$R_{L} = 600 \Omega$ to 1.35 V	Low level	25°C		0.13	0.2	1
. ,				-40°C to 125°C			0.3	
Vo	Output swing			25°C	2.6	2.66		V
		V _{CC+} = 2.7 V,	High level	-40°C to 125°C	2.5			
		$R_L = 2 k\Omega$ to 1.35 V		25°C		0.08	0.12	
			Low level	-40°C to 125°C			0.2	
	0 / / /	V _O = 0 V	Sourcing	25°C	12	16		
lo	Output current	V _O = 2.7 V	Sinking	25°C	12	26		mA
			1	25°C		0.22	0.3	
		LMV821		-40°C to 125°C			0.5	ſ
						0.45	0.6	mA
lcc	Supply current	LMV822 (both amplifiers)		-40°C to 125°C			0.8	
		LMV824 (all four amplifiers)		25°C		0.72	1	
				-40°C to 125°C			1.2	

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2.7-V Electrical Characteristics (continued)

 V_{CC+} = 2.7 V, V_{CC-} = 0 V, V_{IC} = 1 V, V_O = 1.35 V, and R_L > 1 $M\Omega$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	T _A	MIN TYP	MAX	UNIT
SR	Slew rate ⁽¹⁾		25°C	1.7		V/µs
GBW	Gain bandwidth product	(2)	25°C	5		MHz
Φ_{m}	Phase margin	(2)	25°C	60		deg
	Gain margin	(2)	25°C	8.6		dB
	Amplifier-to-amplifier isolation	V_{CC+} = 5 V, R_L = 100 k Ω to 2.5 V ⁽³⁾	25°C	135		dB
Vn	Equivalent input noise voltage	$f = 1 \text{ kHz}, V_{IC} = 1 \text{ V}$	25°C	45		nV/√Hz
l _n	Equivalent input noise current	f = 1 kHz	25°C	0.18		pA/√ Hz
THD	Total harmonic distortion	f = 1 kHz, $A_V = -2$, $R_L = 10$ kΩ, $V_O = 4.1$ V_{p-p}	25°C	0.01		%

Connected as voltage follower with 1-V step input. Value specified is the slower of the positive and negative slew rates. (1)

40-dB closed-loop dc gain, $C_L = 22 \text{ pF}$

(2) (3) Each amplifier excited in turn with 1 kHz to produce $V_0 = 3 V_{p-p}$



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5-V Electrical Characteristics

 V_{CC+} = 5 V, V_{CC-} = 0 V, V_{IC} = 2 V, V_O = 2.5 V, and R_L > 1 $M\Omega$ (unless otherwise noted)

	PARAMETER	TEST CONDI	FIONS	T _A	MIN	TYP	MAX	UNIT
V	Input offset voltage			25°C		1	6	mV
V _{IO}	input onset voltage			-40°C to 125°C			6	mv
α_{VIO}	Average temperature coefficient of input offset voltage			25°C		1		μV/°C
	Input bias current			25°C		40	100	nA
I _{IB}	input bias current			-40°C to 125°C			150	IIA
l	Input offset current			25°C		0.5	30	nA
I _{IO}	input onset current			$-40^{\circ}C$ to $125^{\circ}C$			50	IIA
CMDD	Common-mode rejection ratio	$V_{IC} = 0$ to 4 V		25°C	72	90		dB
CIVINA	Common-mode rejection ratio	$v_{1C} = 0.004$ v		-40°C to 125°C	70			uВ
ık	Positive supply-voltage	$V_{CC+} = 1.7 V$ to 4 V, $V_{CC-} = -1$		25°C	75	85		dB
+k _{SVR}	rejection ratio	$V_0 = 0, V_{IC} = 0$		-40°C to 125°C	70			uБ
Ŀ	Negative supply-voltage	$V_{CC+} = 1.7 \text{ V}, V_{CC-} = -1 \text{ V} \text{ to } -3.3 \text{ V},$		25°C	73	85		٩D
-k _{SVR}	rejection ratio	$V_0 = 0, V_{IC} = 0$		-40°C to 125°C	70			dB
V _{ICR}	Common-mode input voltage range	CMRR ≥ 50 dB		25°C	-0.2 to 4.2	-0.3 to 4.3		V
		$R_{\rm L} = 600 \ \Omega$ to 2.5 V,	Coursing	25°C	95	105		dB
		$V_0^2 = 2.5 \text{ V to } 4.5 \text{ V}$	Sourcing	-40°C to 125°C	90			
		$R_{\rm L} = 600 \ \Omega$ to 2.5 V,		25°C	95	105		
	Large-signal voltage	$V_0 = 2.5 \text{ V to } 0.5 \text{ V}$	Sinking	-40°C to 125°C	90			
A _V	amplification	$R_{\rm L} = 2 \ \text{k}\Omega \text{ to } 2.5 \ \text{V},$	0	25°C	95	105		
		$V_0^{L} = 2.5 \text{ V to } 4.5 \text{ V}$	Sourcing	–40°C to 125°C	90			
		$\label{eq:RL} \begin{array}{l} R_{L} = 2 \; k \Omega \; \text{to} \; 2.5 \; V, \\ V_{O} = 2.5 \; V \; \text{to} \; 0.5 \; V \end{array}$	O's Lissa	25°C	95	105		
			Sinking	-40°C to 125°C	90			
			High level	25°C	4.75	4.84		-
		V _{CC+} = 5 V,		-40°C to 125°C	4.6			
		$R_L = 600 \Omega$ to 2.5 V		25°C		0.17	0.25	
. /			Low level	-40°C to 125°C			0.3	N
Vo	Output swing			25°C	4.85	4.9		V
		V _{CC+} = 5 V,	High level	-40°C to 125°C	4.8			
		$R_L = 2 k\Omega$ to 2.5 V		25°C		0.1	0.15	
			Low level	-40°C to 125°C			0.2	
		N/ 0.1/	Councies	25°C	20	45		
	Output ourset	$V_0 = 0 V$	Sourcing	-40°C to 125°C	15			
l _o	Output current		Circlein a	25°C	20	40		mA
		$V_{O} = 5 V$	Sinking	-40°C to 125°C	15			ŀ
		1 M//921		25°C		0.3	0.4	
		LMV821		-40°C to 125°C			0.6	
	Cupply ourrent		-	25°C		0.5	0.7	-
I _{CC}	Supply current	LIVIV822 (both amplifier	LMV822 (both amplifiers)				0.9	mA
				25°C		1	1.3	
		LMV824 (all four amplifi	-40°C to 125°C			1.5	[

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5-V Electrical Characteristics (continued)

 V_{CC+} = 5 V, V_{CC-} = 0 V, V_{IC} = 2 V, V_{O} = 2.5 V, and R_{L} > 1 $M\Omega$ (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	T _A	MIN	TYP	MAX	UNIT
SR	Slew rate	$V_{CC+} = 5 V^{(1)}$	25°C	1.4	1.9		V/µs
GBW	Gain bandwidth product	(2)	25°C		5.5		MHz
Φ_{m}	Phase margin	(2)	25°C		64.2		deg
	Gain margin	(2)	25°C		8.7		dB
	Amplifier-to-amplifier isolation	V_{CC+} = 5 V, R_L = 100 k Ω to 2.5 V $^{(3)}$	25°C		135		dB
V _n	Equivalent input noise voltage	f = 1 kHz, V _{IC} = 1 V	25°C		42		nV/√Hz
I _n	Equivalent input noise current	f = 1 kHz	25°C		0.2		pA/√ Hz
THD	Total harmonic distortion	f = 1 kHz, $A_V = -2$, $R_L = 10$ kΩ, V _O = 4.1 V _{p-p}	25°C		0.01		%

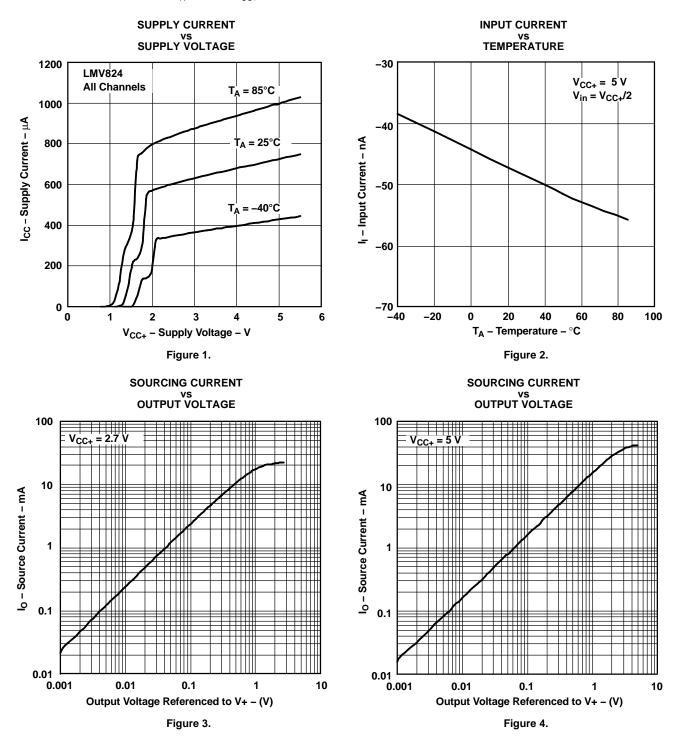
Connected as voltage follower with 3-V step input. Value specified is the slower of the positive and negative slew rates. (1)

40-dB closed-loop dc gain, $C_L = 22 \text{ pF}$ Each amplifier excited in turn with 1 kHz to produce $V_O = 3 \text{ V}_{p-p}$ (2) (3)



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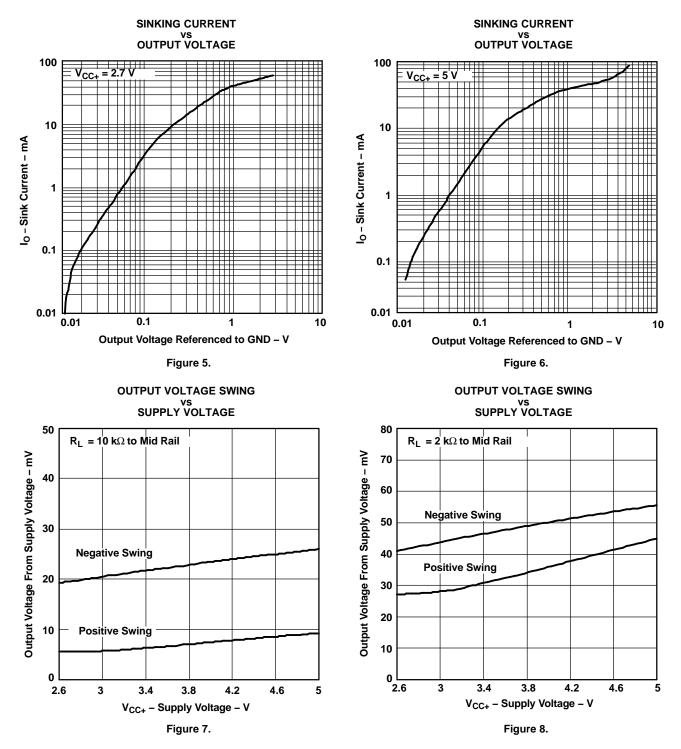
TYPICAL CHARACTERISTICS





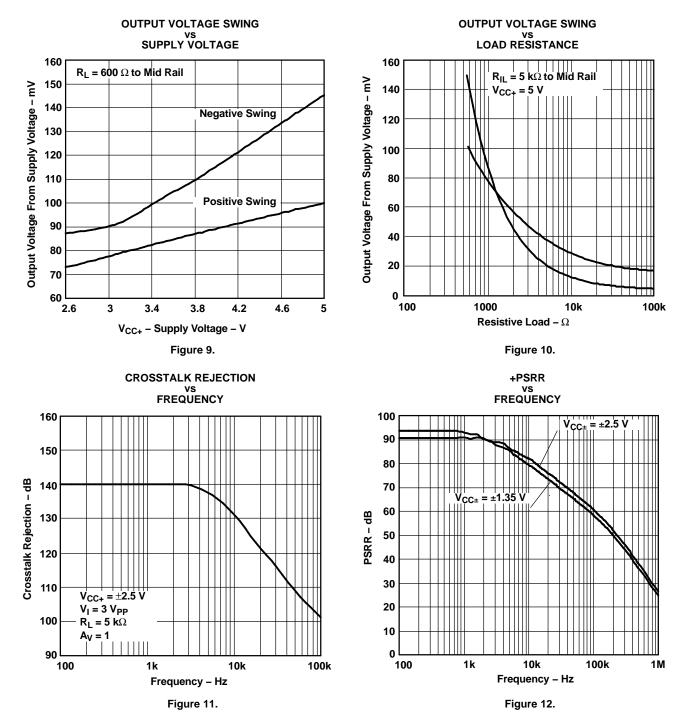
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TYPICAL CHARACTERISTICS (continued)



TYPICAL CHARACTERISTICS (continued)

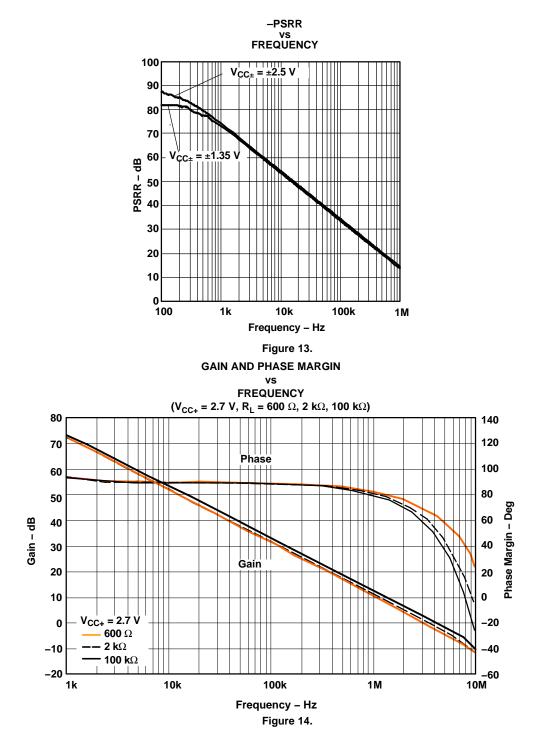
 $T_A = 25^{\circ}C$, $V_{CC+} = 5$ -V Single Supply (Unless Otherwise Noted)



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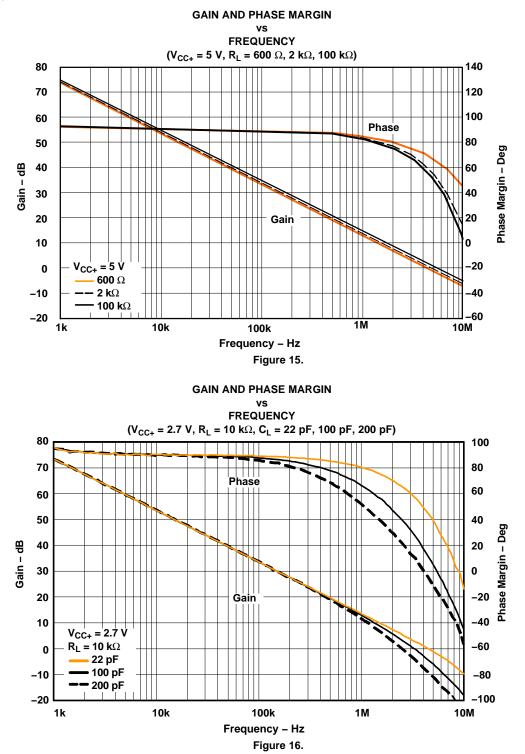
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TYPICAL CHARACTERISTICS (continued)

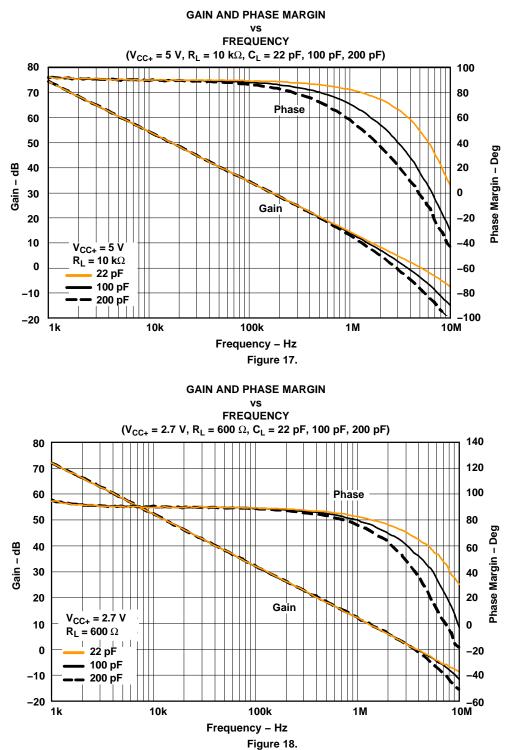




TYPICAL CHARACTERISTICS (continued)

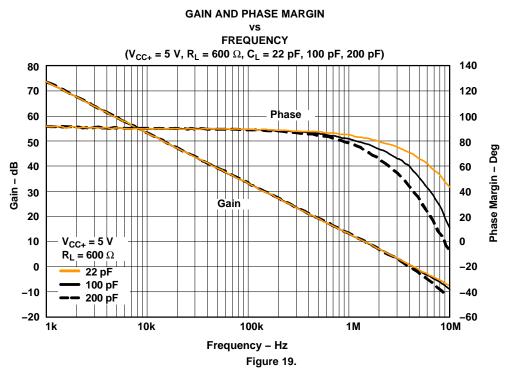


TYPICAL CHARACTERISTICS (continued)





TYPICAL CHARACTERISTICS (continued)



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins P	ackage Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LMV821QDBVRQ1	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
LMV822QDGKRQ1	ACTIVE	MSOP	DGK	8	2500	Green (RoHS & no Sb/Br)	CU SNPB	Level-2-260C-1 YEAR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

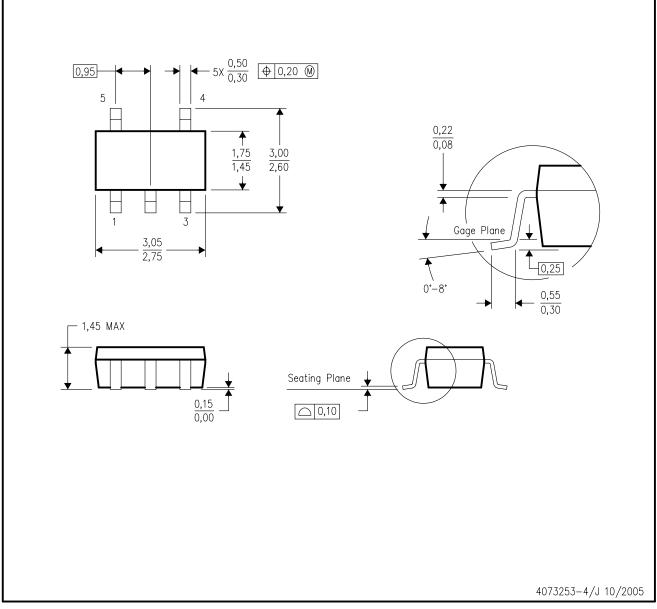
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

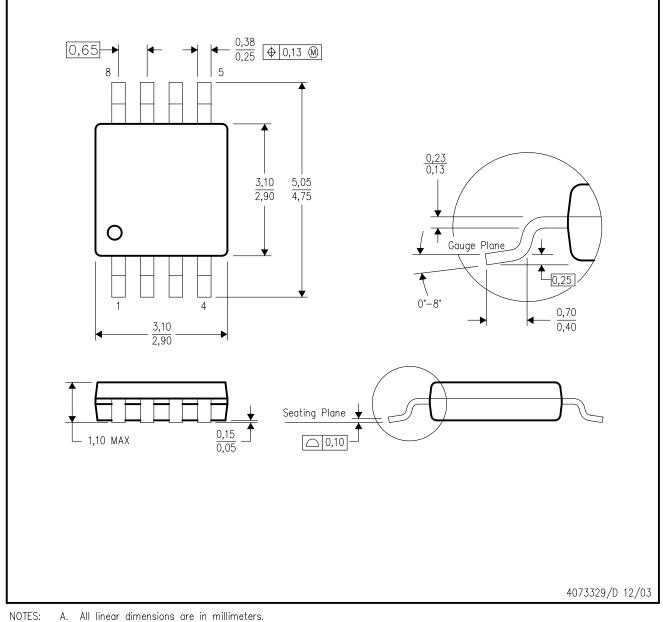
C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.

D. Falls within JEDEC MO-178 Variation AA.



DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-187 variation AA.



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